



### **General Description**

The WSP4099 is the highest performance trench P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4099 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

### **Product Summery**

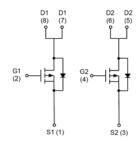
BVDSS	RDSON	ID
-40V	30mΩ	-6.5A

### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

# **SOP-8 Pin Configuration**





# **Absolute Maximum Ratings**

Symbol	Parameter Rating		Units
$V_{DS}$	Drain-Source Voltage	-40	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, -V <sub>GS</sub> @ -10V <sup>1</sup>	-6.5	Α
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current, -V <sub>GS</sub> @ -10V <sup>1</sup>	-4.5	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-22	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	25	mJ
I <sub>AS</sub>	Avalanche Current	-10	Α
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation⁴	2.0	W
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}\! \mathbb{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^{\circ}$

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>		110	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		50	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0 $V$ , $I_D$ =-250 $u$ A	-40			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA		-0.02		V/°C
D	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-6.5A		30	38	D
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-4.5A		46	62	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		-1.5	-2.0	-2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS , ID250UA		3.72		V/°C
l	Drain Source Leakage Current	Source Leakage Current			1	uA
I <sub>DSS</sub>	Dialii-Source Leakage Current				5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	$V_{DS}$ =-5 $V$ , $I_D$ =-4 $A$		8		S
$Q_g$	Total Gate Charge (-4.5V)	V <sub>DS</sub> =-20V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-6.5A		7.5		
$Q_gs$	Gate-Source Charge			2.4		nC
$Q_gd$	Gate-Drain Charge			3.5		
T <sub>d(on)</sub>	Turn-On Delay Time			8.7		
Tr	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_{G}$ =6 $\Omega$ ,		7		20
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-1A ,R <sub>L</sub> =20Ω		31		ns
T <sub>f</sub>	Fall Time			17		
C <sub>iss</sub>	Input Capacitance			668		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		98		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			72		

#### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =-25V , L=0.5mH , I <sub>AS</sub> =-10A	20			mJ

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,6</sup>	-V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-2	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>				-22	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1.0	V

### Note:

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.
- 2. The data tested by pulsed , pulse width  $\leq 300$ us , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is VDD=-25V,VGS=-10V,L=0.5mH,IAS=-10A
- 4.The power dissipation is limited by 150  $^{\circ}\mathrm{C}$  junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**

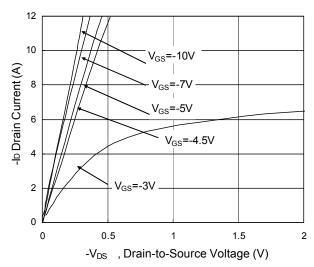


Fig.1 Typical Output Characteristics

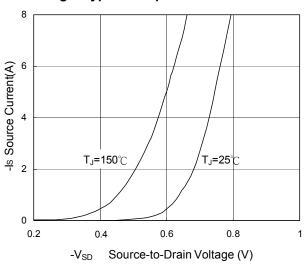


Fig.3 Forward Characteristics Of Reverse

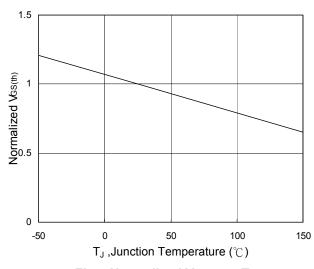


Fig.5 Normalized V<sub>GS(th)</sub> v.s T<sub>J</sub>

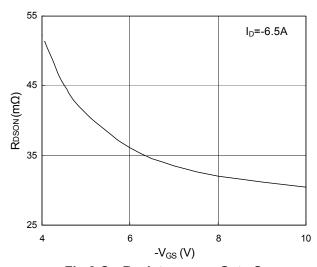
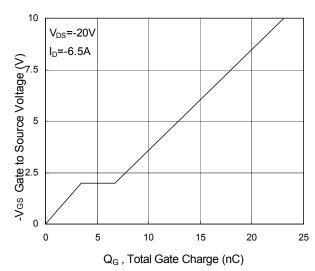


Fig.2 On-Resistance v.s Gate-Source



**Fig.4 Gate Charge Characteristics** 

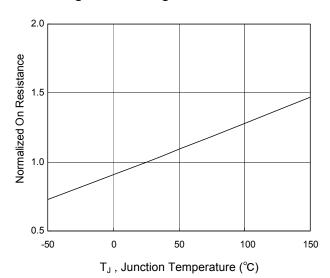
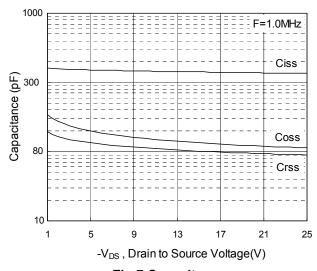


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>





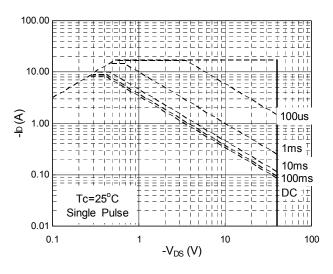


Fig.7 Capacitance

Fig.8 Safe Operating Area

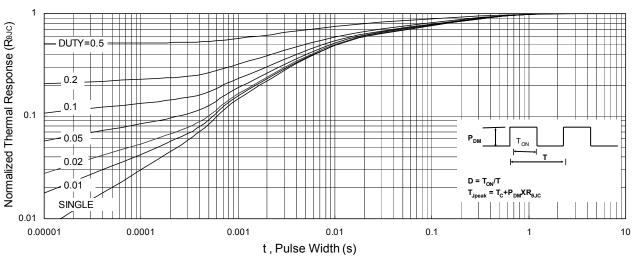


Fig.9 Normalized Maximum Transient Thermal Impedance

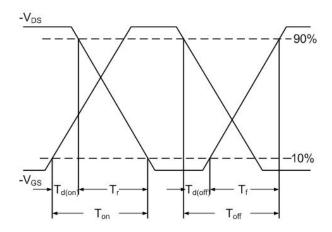
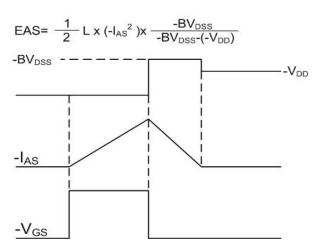


Fig.10 Switching Time Waveform



**Fig.11 Unclamped Inductive Waveform** 



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